

Product Obsolescence Memo

Bourns Manufacturers Representatives Corporate Distributor Product Managers Americas Sales Team Asia Sales Team Europe Sales Team



January, 2008

Non-RoHS Compliant Diode Part Number End of Life

Bourns has successfully provided RoHS compliant diodes with part number suffix "LF" to our customers since January 2005, with the result that the majority of Bourns customers have already switched to RoHS compliant part numbers during the past 3 years.

Due to lack of orders for SnPb models over the past 12 months with customers preferring to use RoHS compliant parts instead, effective immediately Bourns will no longer accept orders for diode part numbers using SnPb termination plating (without "LF" suffix).

The affected Bourns[®] part numbers include the following part number series:

CD214A-B Series	CD214A-T Series	CD214B-B Series	CD214B-T Series
CD214C-B Series	CD214C-T Series	CD216A-B Series	CD1607-B Series

To avoid customer production down time, Bourns is strongly urging and requesting that customers using Bourns[®] diode part numbers (without suffix "LF") switch to alternative lead free part numbers using the "LF" suffix with 100 % matte tin plating.

The RoHS compliant Bourns^{\circ} diode part number with the "LF" suffix is backward compatible to the SnPb lower temperature 235 °C ~ 240 °C solder reflow process. I have attached solder bath temperature data to support the backward compatibility.

ESD0804



Bourns Inc.

HI-REL EXPERIMENT SUMMARY

DEPARTI PRODUC CRITERIA NO.	т:	QA SMD Vf(V)< PIV(V)> IR(uA)<	SnPb bath	mV v uA	@IF= A @IR= uA @PIV= V Machine No.	DURATION	FAILURE RATE	PARAM	IETER	X BAR	DATE : EXP.# : LOT NO: D/C : P/N: S DEV.	AUG/17/2006 N/A N/A N/A N/A MAX.	MIN.
	SMA												
М	Solderability	225 +/- 5°C			Q0136	5 SECS	0/10						
м	SMA Solderability	240 +/- 5°C			Q0136	5 SECS	0/10	_	_	_	_	_	_
	SMB												
М	Solderability	225 +/- 5°C			Q0136	5 SECS	0/10						
м	SMB Solderability	240 +/- 5°C			Q0136	5 SECS	0/10		_	_	_	_	
М	SMC Solderability	225 +/- 5°C			Q0136	5 SECS	0/10		-		_	-	
М	SMC Solderability	240 +/- 5°C			Q0136	5 SECS	0/10				_	-	

COMMENTS :

TESTED BY : Zhang-xiaomei

COMMENTS:

ENGINEER :_____

MANAGER :_____

FIV-QA35-1

PART NO:	SMA	DATE :	AUG/17/2006
TEST ITEM :	Solderability	EXP.# :	N/A
TEST CONDITION :	225 +/- 5°C	LOT NO:	N/A
		D/C :	N/A
DURATION :	5 SECS	P/N:	N/A





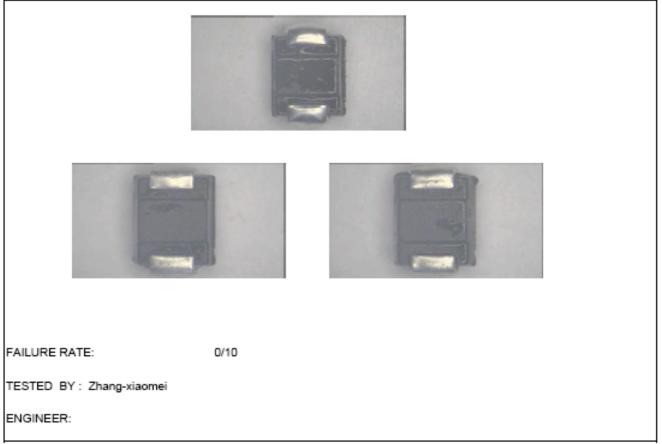


FAILURE RATE: 0/10

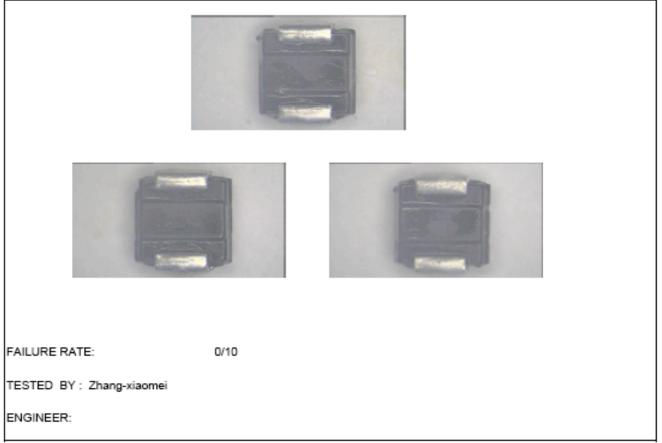
TESTED BY : Zhang-xiaomei

ENGINEER:

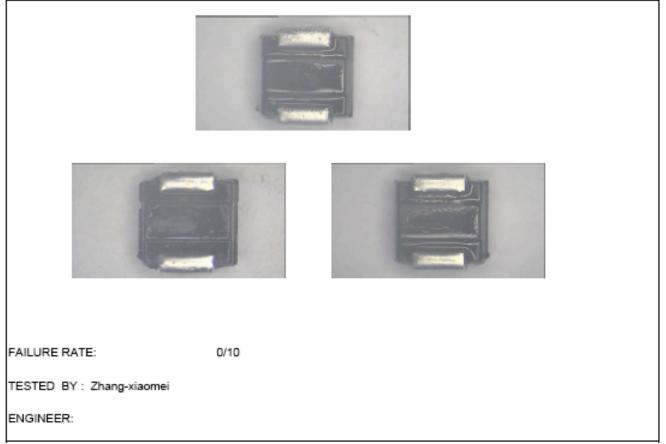
PART NO:	SMA	DATE :	AUG/17/2008
TEST ITEM:	Solderability	EXP.#:	N/A
TEST CONDITION :	240 +/- 5°C	LOT NO:	N/A
		D/C:	N/A
DURATION :	5 SECS	P/N:	N/A



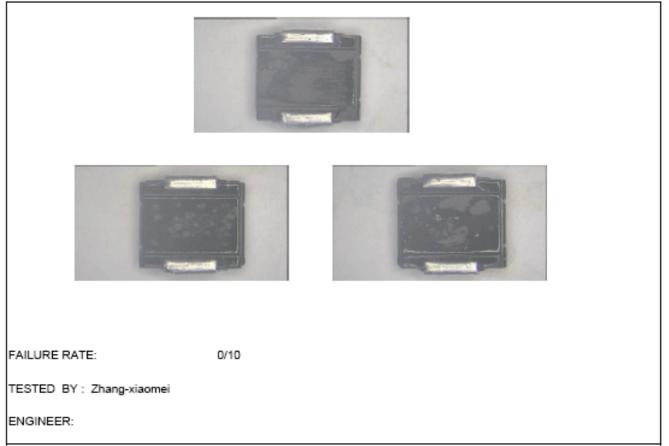
PART NO:	SMB	DATE :	AUG/17/2008
TEST ITEM :	Solderability	EXP.#:	N/A
TEST CONDITION :	225 +/- 5°C	LOT NO:	N/A
		D/C :	N/A
DURATION :	5 SECS	P/N:	N/A



PART NO:	SMB	DATE :	AUG/17/2008
TEST ITEM:	Solderability	EXP.#:	N/A
TEST CONDITION :	240 +/- 5°C	LOT NO:	N/A
		D/C:	N/A
DURATION :	5 SECS	P/N:	N/A



PART NO:	SMC	DATE :	AUG/17/2008
TEST ITEM:	Solderability	EXP.#:	N/A
TEST CONDITION :	225 +/- 5°C	LOT NO:	N/A
		D/C :	N/A
DURATION :	5 SECS	P/N:	N/A



PART NO:	SMC	DATE :	AUG/17/2006
TEST ITEM:	Solderability	EXP.#:	N/A
TEST CONDITION :	240 +/- 5°C	LOT NO:	N/A
		D/C :	N/A
DURATION :	5 SECS	P/N:	N/A

